

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
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HYUN AH MOON	01/05/2017
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15324277
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DATE SIGNED:	01/06/2017
Total Attachments: 1	
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ASSIGNMENT OF PATENT APPLICATION

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned, do hereby:

SELL, ASSIGN AND TRANSFER to Saewha Jeon (the "Assignee"), having a place of business at 56-9, Banpo-daero 39-gil, Seocho-gu, Seoul 137-807, Republic of Korea, the entire right, title and interest for the United States and all foreign countries in and to any and all inventions, subject matter and improvements disclosed in the application for United States Letters Patent, Serial No. 15/324,277, which has been filed on January 6, 2017 and is entitled "A METHOD FOR PREPARING A THREE-Dimensionally CULTURED SKIN COMPRISING DERMIS AND EPIDERMIS, AND THE CULTURED SKIN MADE THEREFROM" (the "Invention"), such application and any and all divisional, continuing, substitute, renewal, reissue and other applications for patent which have been or shall be filed in the United States and all foreign countries based on the Invention; all original, reissued and reexamined patents which have been or shall be issued in the United States and all foreign countries based on the Invention; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States;

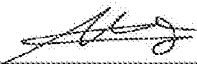
AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for vesting title to such improvements in the Assignee, and for securing, maintaining and enforcing proper patent protection for such improvements;

TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.


IN WITNESS WHEREOF, I have hereunto signed my name on the day and year set forth below.



Yun Hee Kim

Jan. 06. 2017

Date



Hyun Ah Moon

Jan. 05. 2017

Date